



RECORD  
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07-02-2001



RAV-001

To the Honorable Commissioner of Patents and

101765463

original documents or copy thereof.

1. Name of Conveying party(ies):  
Sundaram Ravikumar

06/21/01

2. Name and address of receiving party(ies):

Arvik Enterprises, LLC

265 Hardscrabble Road  
Briarcliff Manor, NY 10510

j1046 U.S. PTO  
09/886545



06/21/01

3. Nature of conveyance:

- ☒ Assignment                      ☐ Merger  
☐ Security Agreement              ☐ Change of Name

Execution Date: 6/21/01

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 6/21/01

A. Patent Application No.(s)

09/886545

B. Patent No.(s)

5. Name and address of party to whom correspondence concerning document should be mailed:

David P. Gordon  
65 Woods End Road  
Stamford, CT 06905

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41)..... \$40

☒ Enclosed

☐ Authorized to charge deposit account

8. Deposit account number: 07-1732  
(attach duplicate page if paying by deposit account)

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

David P. Gordon

Name of Person Signing

*David P. Gordon*  
Signature

June 21, 2001  
Date

Total number of pages including cover sheet, attachments, and document:

3

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## ASSIGNMENT

WHEREAS, we, **Thomas O. Bales and Scott L. Jahrmarkt**, hereinafter referred to as the "Inventors", both citizens of the US, whose post office addresses are respectively,

9151 Arvida Lane, Coral Gables, FL 33156; and  
1820 Bay Drive, Miami Beach, FL 33141

have invented certain new and useful improvements in

### **METHOD FOR MICROPOROUS SURFACE MODIFICATION OF IMPLANTABLE METALLIC MEDICAL ARTICLES AND IMPLANTABLE METALLIC MEDICAL ARTICLES HAVING SUCH MODIFIED SURFACE**

as described and set forth in an application for Letters Patent of the United States of America, executed by us on the 20<sup>th</sup> day of June 2001  
(Docket No.SYN-055).

AND WHEREAS, **SYNTHEON, LLC**, hereinafter referred to as the "said COMPANY", a corporation duly organized, incorporated, and existing under the laws of Florida , and having a place of business at 8210 NW 27th Street, Miami, FL 33122, is desirous of acquiring or confirming its acquisition of the entire right, title and interest in and to said invention, inventions or improvements, and in and to said application, and in and to any and all patents, both of the United States and of all foreign countries, that may be obtained therefor;

NOW, THEREFORE TO ALL WHOM IT MAY CONCERN, BE IT KNOWN, that we, the Inventors, for good and valuable considerations, the receipt and sufficiency of which we hereby acknowledge, have sold, assigned, transferred and conveyed, and by this assignment do sell, assign, transfer and convey, unto said COMPANY, its successors and assigns, the entire right, title and interest throughout the world, in and to our invention, inventions or improvements described or set forth in said application, in any form or embodiment thereof, and in and to said application, and in and to any applications filed in any foreign country based thereon, including the right to file foreign applications under the provisions of any convention or treaty; and in and to any confirmation, divisional, continuation, continuation-in-part, or substitute application which may filed on said invention, inventions or improvements in the United States or in any foreign country; and in and to any and all patents, certificates, utility models, reissues, extensions, additions or confirmations thereof which may be granted in the United States or in any foreign country upon said invention, inventions or improvements, TO HAVE AND TO HOLD the same to the full end of the term or terms for which any and all such United States and foreign patents and grants may be issued on said invention, inventions or improvements.

AND we do hereby authorize and request the issuing authority to issue any and all of said United States and foreign patents on said application or applications to said COMPANY, its successors and assigns, as the assignees of the entire right, title and interest in and to the same, for the sole use and benefit of said COMPANY, its successors and assigns.

AND we do hereby covenant and warrant that we have full right to convey the entire right, title and interest herein assigned free and clear of all licenses, encumbrances and liens whatsoever, and that we have not executed and will not execute any instruments in conflict herewith.

